



SN74LS247 (LX) BCD-to-Seven-Segment Decodes/Drivers

Product Specification

Specification Revision History:

Version	Date	Description
2023-05-A1	2023-05	New



Contents

1、General Description.....	3
2、Block Diagram And Pin Description	6
2.1、Block Diagram	6
2.2、Pin Configurations.....	6
2.3、Pin Description.....	7
2.4、Function Table.....	7
3、Electrical Parameter	8
3.1、Absolute Maximum Ratings.....	8
3.2、Recommended Operating Conditions	9
3.3、Electrical Characteristics.....	9
3.3.1、DC Characteristics 1.....	9
3.3.2、DC Characteristics 2.....	10
3.3.3、AC Characteristics.....	11
4、Testing Circuit	11
4.1、AC Testing Circuit	11
4.2、Test Data	12
4.3、AC Testing Waveforms.....	12
4.4、Measurement Points	12
5、Package Information	13
5.1、DIP16	13
5.2、SOP16	14
5.3、TSSOP16.....	15
6、Statements And Notes	16
6.1、The name and content of Hazardous substances or Elements in the product.....	16
6.2、Notes	16



1、General Description

The SN74LS247 feature active-low outputs designed for driving common-anode LEDs or incandescent indicators directly. Display patterns for BCD input counts above 9 are unique symbols to authenticate input conditions.

Features:

- Temperature range: -40°C to +125°C
- Packaging information: DIP16/SOP16/TSSOP16



Ordering Information:

Tube packing specifications:

Part number	Packaging form	Marking code	Tube quantity	Boxed tube quantity	Boxed quantity	Notes
SN74LS247N (LX)	DIP16	SN74LS247N	25 PCS/tube	40 tube/box	1000 PCS/box	Dimensions of plastic enclosure: 19.0mm×6.4mm Pin spacing: 2.54mm
SN74LS247D (LX)	SOP16	LS247	50 PCS/tube	200 tube/box	10000 PCS/box	Dimensions of plastic enclosure: 10.0mm×3.9mm Pin spacing: 1.27mm
SN74LS247PW(LX)	TSSOP16	LS247	96 PCS/tube	200 tube/box	19200 PCS/box	Dimensions of plastic enclosure: 5.0mm×4.4mm Pin spacing: 0.65mm



Reel packing specifications:

Part number	Packaging form	Marking code	Reel quantity	Boxed reel quantity	Notes
SN74LS247DR (LX)	SOP16	LS247	2500 PCS/reel	5000 PCS/box	Dimensions of plastic enclosure: 10.0mm×3.9mm Pin spacing: 1.27mm
SN74LS247PW (LX)	TSSOP16	LS247	5000 PCS/reel	10000 PCS/box	Dimensions of plastic enclosure: 5.0mm×4.4mm Pin spacing: 0.65mm

Note: If the physical information is inconsistent with the ordering information, please refer to the actual product.



2、Block Diagram And Pin Description

2.1、Block Diagram

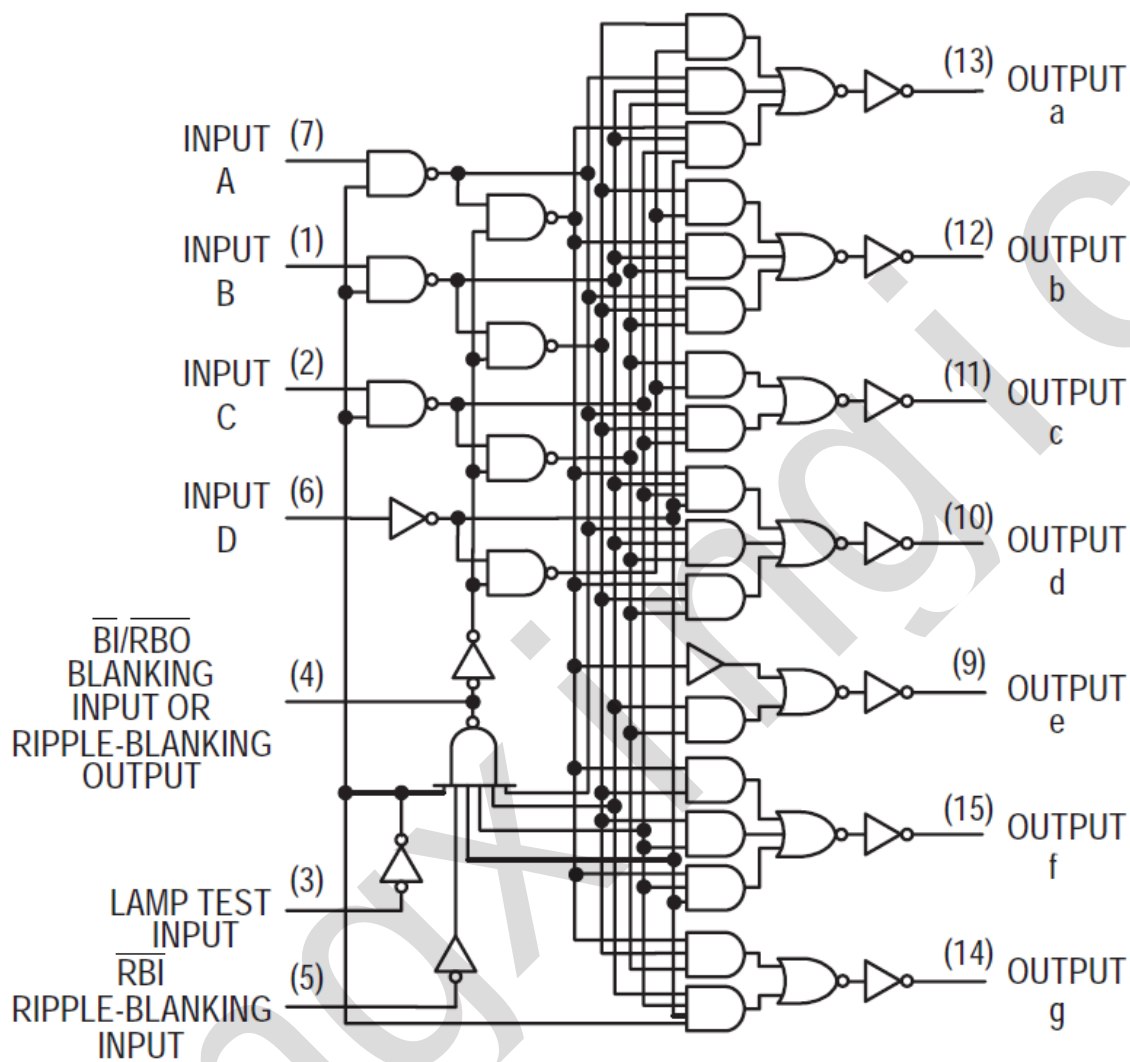


Figure 1. Logic diagram

2.2、Pin Configurations

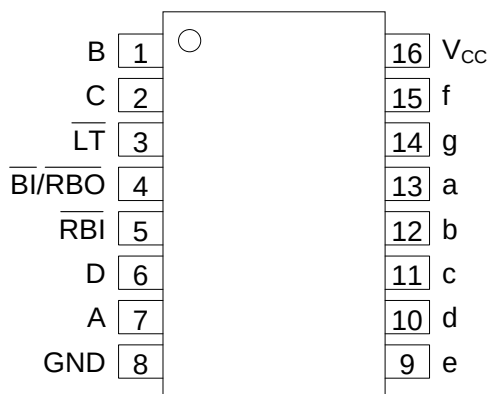


Figure 2. Pin configurations



2.3、Pin Description

Pin No.	Pin Name	Description
1	B	data input
2	C	data input
3	LT	lamp test
4	$\overline{\text{BI}}/\text{RBO}$	blanking input/ripple blanking output
5	$\overline{\text{RBI}}$	ripple blanking input
6	D	data input
7	A	data input
8	GND	ground (0V)
9	e	data output
10	d	data output
11	c	data output
12	b	data output
13	a	data output
14	g	data output
15	f	data output
16	V_{CC}	supply voltage

2.4、Function Table

Decimal or function	Input						$\overline{\text{BI}}/\text{RBO}$	Output						
	$\overline{\text{LT}}$	$\overline{\text{RBI}}$	D	C	B	A		a	b	c	d	e	f	g
0	H	H	L	L	L	L	H	on	on	on	on	on	on	off
1	H	X	L	L	L	H	H	off	on	on	off	off	off	off
2	H	X	L	L	H	L	H	on	on	off	on	on	off	on
3	H	X	L	L	H	H	H	on	on	on	on	off	off	on
4	H	X	L	H	L	L	H	off	on	on	off	off	on	on
5	H	X	L	H	L	H	H	on	off	on	on	off	on	on
6	H	X	L	H	H	L	H	on	off	on	on	on	on	on
7	H	X	L	H	H	H	H	on	on	on	off	off	off	off
8	H	X	H	L	L	L	H	on	on	on	on	on	on	on
9	H	X	H	L	L	H	H	on	on	on	on	off	on	on
10	H	X	H	L	H	L	H	off	off	off	on	on	off	on
11	H	X	H	L	H	H	H	off	off	on	on	off	off	on
12	H	X	H	H	L	L	H	off	on	off	off	off	on	on
13	H	X	H	H	L	H	H	on	off	off	on	off	on	on
14	H	X	H	H	H	L	H	off	off	off	on	on	on	on
15	H	X	H	H	H	H	H	off	off	off	off	off	off	off
$\overline{\text{BI}}$	X	X	X	X	X	X	L	off	off	off	off	off	off	off
$\overline{\text{RBI}}$	H	L	L	L	L	L	L	off	off	off	off	off	off	off
$\overline{\text{LT}}$	L	X	X	X	X	X	H	on	on	on	on	on	on	on



Note:

- [1] H=HIGH voltage level; L=LOW voltage level; X=don't care.
- [2] The blanking input ($\overline{\text{BI}}$) must be open or held at a high logic level when output functions 0 through 15 are desired. The ripple-blanking input ($\overline{\text{RBI}}$) must be open or high if blanking of a decimal zero is not desired.
- [3] When a low logic level is applied directly to the blanking input ($\overline{\text{BI}}$), all segment outputs are off regardless of the level of any other input.
- [4] When ripple-blanking input ($\overline{\text{RBI}}$) and inputs A, B, C, D are at a low level with the lamp test input high, all segment outputs go off and the ripple-blanking output ($\overline{\text{RBO}}$) goes to a low level (response condition).
- [5] When the blanking input/ripple blanking output ($\overline{\text{BI/RBO}}$) is open or held high and a low is applied to the lamp test input, all segment outputs are on.



Figure 3. Segment identification

3、Electrical Parameter

3.1、Absolute Maximum Ratings

(Voltages are referenced to GND (ground=0V), unless otherwise specified.)

Parameter	Symbol	Conditions	Min.	Max.	Unit
supply voltage	V_{CC}	-	-0.5	+7	V
supply current	I_{CC}	-	-	50	mA
ground current	I_{GND}	-	-50	-	mA
input clamping current	I_{IK}	$V_I < -0.5V$ or $V_I > V_{CC} + 0.5V$	-	± 20	mA
output clamping current	I_{OK}	$V_O < -0.5V$ or $V_O > V_{CC} + 0.5V$	-	± 20	mA
output current	I_O	$-0.5V < V_O < V_{CC} + 0.5V$	-	± 25	mA
storage temperature	T_{stg}	-	-65	+150	$^{\circ}C$
soldering temperature	T_L	10s	DIP		245
			SOP/TSSOP		260



3.2、Recommended Operating Conditions

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
supply voltage	V_{CC}	-	2.0	5.0	6.0	V
input voltage	V_I	-	0	-	V_{CC}	V
output voltage	V_O	-	0	-	V_{CC}	V
ambient temperature	T_{amb}	-	-40	-	+125	°C

3.3、Electrical Characteristics

3.3.1、DC Characteristics 1

(T_{amb} =-40°C to +85°C, voltages are referenced to GND (ground=0V), unless otherwise specified.)

Parameter	Symbol	V_{CC}	Conditions	Min.	Typ.	Max.	Unit
HIGH-level input voltage	V_{IH}	2.0V	-	1.5	1.2	-	V
		4.5V	-	3.15	2.4	-	V
		6.0V	-	4.2	3.2	-	V
LOW-level input voltage	V_{IL}	2.0V	-	-	0.8	0.5	V
		4.5V	-	-	2.1	1.35	V
		6.0V	-	-	2.8	1.8	V
LOW-level output voltage	V_{OL}	2.0V	$I_O=20\mu A$	-	0	0.1	V
		4.5V	$I_O=20\mu A$	-	0	0.1	V
		6.0V	$I_O=20\mu A$	-	0	0.1	V
		4.5V	$I_O=4.0mA$	-	0.15	0.33	V
		6.0V	$I_O=5.2mA$	-	0.16	0.33	V
HIGH-level input current	I_{IH}	6.0V	$V_I=V_{CC}$	-	-	20	μA
LOW-level input current	$I_{IL}(A/B/C/D)$	6.0V	$V_I=GND$	-	-	-20	μA
	$I_{IL}(BI/\overline{RBO}/\overline{RBI}/\overline{LT})$	6.0V	$V_I=GND$	-	-	-1.2	mA
supply current	I_{CC}	6.0V	$V_I=V_{CC}$ or GND; $I_O=0A$	-	-	13	mA



3.3.2、DC Characteristics 2

($T_{amb} = -40^{\circ}\text{C}$ to $+125^{\circ}\text{C}$, voltages are referenced to GND (ground=0V), unless otherwise specified.)

Parameter	Symbol	V_{CC}	Conditions	Min.	Typ.	Max.	Unit
HIGH-level input voltage	V_{IH}	2.0V	-	1.5	-	-	V
		4.5V	-	3.15	-	-	V
		6.0V	-	4.2	-	-	V
LOW-level input voltage	V_{IL}	2.0V	-	-	-	0.5	V
		4.5V	-	-	-	1.35	V
		6.0V	-	-	-	1.8	V
LOW-level output voltage	V_{OL}	2.0V	$I_O = 20\mu\text{A}$	-	-	0.1	V
		4.5V	$I_O = 20\mu\text{A}$	-	-	0.1	V
		6.0V	$I_O = 20\mu\text{A}$	-	-	0.1	V
		4.5V	$I_O = 4.0\text{mA}$	-	-	0.4	V
		6.0V	$I_O = 5.2\text{mA}$	-	-	0.4	V
HIGH-level input current	I_{IH}	6.0V	$V_I = V_{CC}$	-	-	20	μA
LOW-level input current	$I_{IL}(A/B/C/D)$	6.0V	$V_I = \text{GND}$	-	-	-20	μA
	$I_{IL}(\overline{BI}/\overline{RBO}/\overline{RBI}/\overline{LT})$	6.0V	$V_I = \text{GND}$	-	-	-1.2	mA
supply current	I_{CC}	6.0V	$V_I = V_{CC}$ or GND; $I_O = 0\text{A}$	-	-	13	mA



3.3.3、AC Characteristics

($T_{amb}=25^{\circ}\text{C}$, voltages are referenced to GND (ground=0V), unless otherwise specified.)

Parameter	Symbol	V_{CC}	Conditions		Min.	Typ.	Max.	Unit
Turn-on time	t_{ON}	5.0V	$C_L=15\text{pF}$	from A input	-	-	100	ns
Turn-off time	t_{OFF}	5.0V	$C_L=15\text{pF}$	from RBI input, outputs (a-f only)	-	-	100	ns

4、Testing Circuit

4.1、AC Testing Circuit

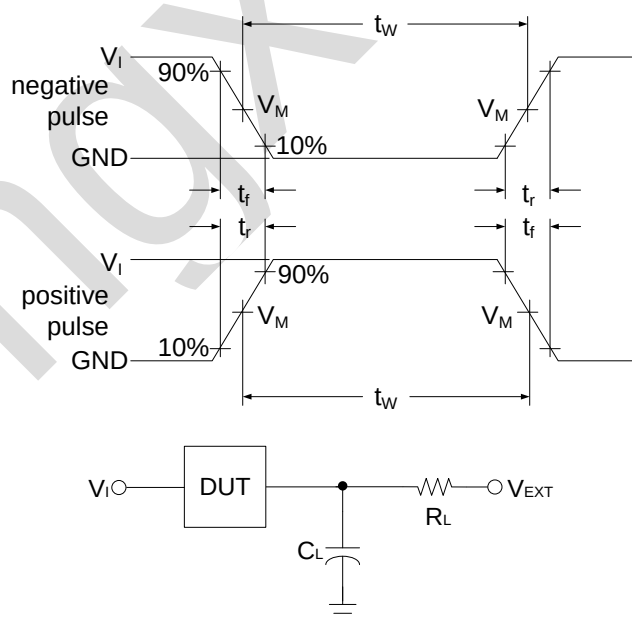


Figure 4. Test circuit for measuring switching times

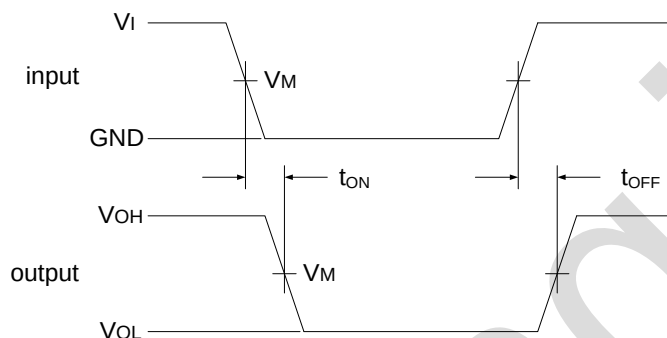
C_L includes probe and jig capacitance.



4.2、Test Data

Input		Load		V_{EXT}
V_I	$t_r = t_f$	C_L	R_L	t_{ON}/t_{OFF}
V_{CC}	3.0ns	15pF	665 Ω	V_{CC}

4.3、AC Testing Waveforms



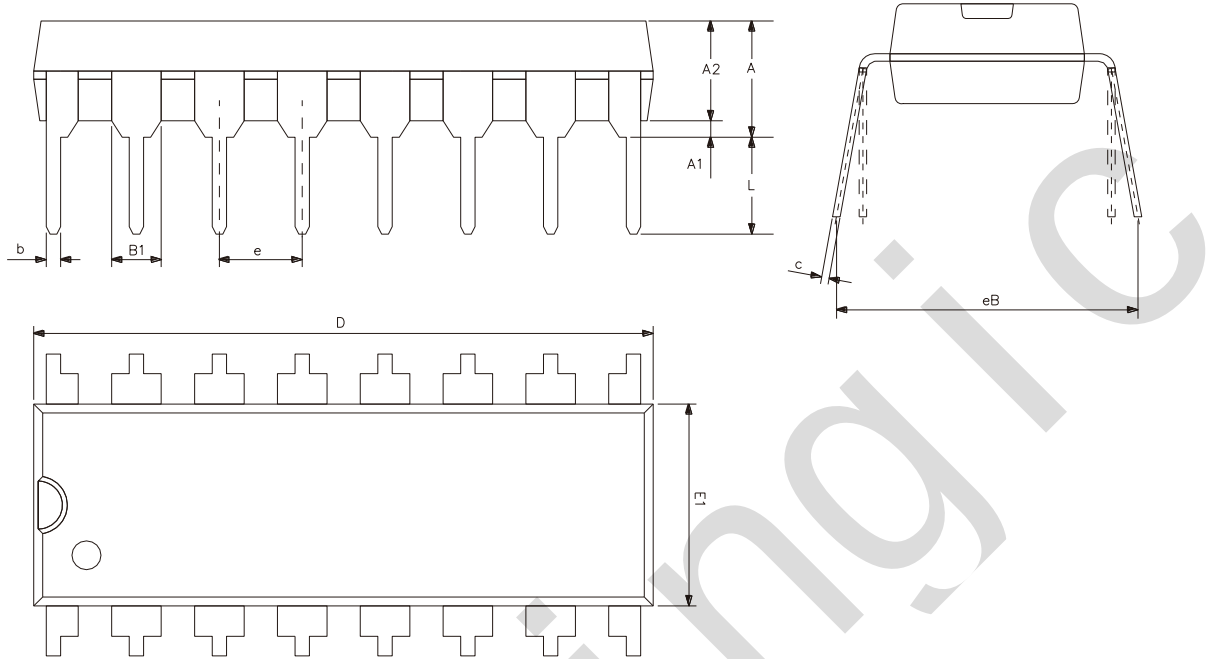
4.4、Measurement Points

Input	Output
V_M	V_M
$0.5 \times V_{CC}$	$0.5 \times V_{CC}$



5、Package Information

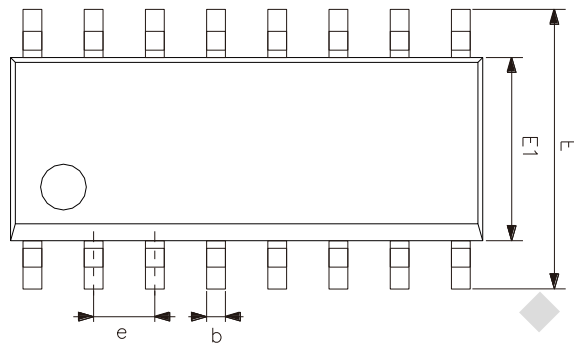
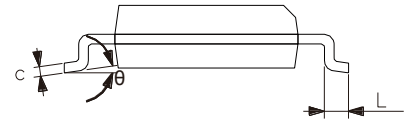
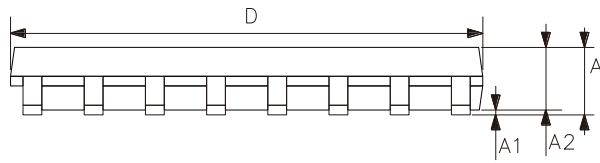
5.1、DIP16



Symbol	Dimensions (mm)	
	Min.	Max.
A2	3.20	3.60
A1	0.51	-
A	3.60	5.33
L	3.00	3.60
b	0.36	0.56
B1	1.52	
D	18.80	19.94
E1	6.20	6.60
e	2.54	
c	0.20	0.36
eB	7.62	9.30



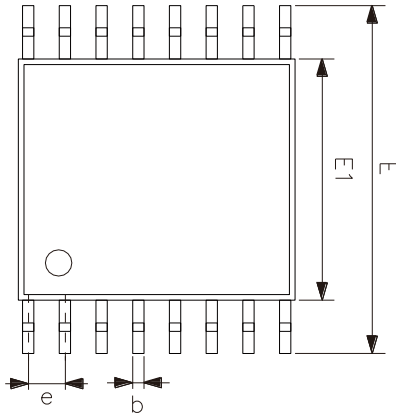
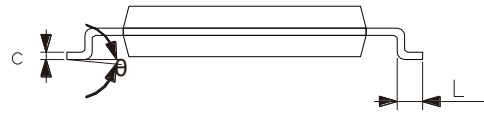
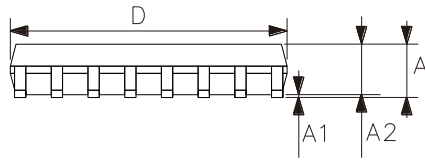
5.2、SOP16



Symbol	Dimensions (mm)	
	Min.	Max.
A	1.35	1.80
A1	0.10	0.25
A2	1.25	1.55
b	0.33	0.51
c	0.19	0.25
D	9.50	10.10
E	5.80	6.30
E1	3.70	4.10
e	1.27	
L	0.35	0.89
θ	0°	8°



5.3、TSSOP16



Symbol	Dimensions (mm)	
	Min.	Max.
A	-	1.20
A1	0.05	0.15
A2	0.80	1.05
b	0.19	0.30
c	0.09	0.20
D	4.90	5.10
E1	4.30	4.50
E	6.20	6.60
e	0.65	
L	0.45	0.75
θ	0°	8°



6、Statements And Notes

6.1、The name and content of Hazardous substances or Elements in the product

Part name	Hazardous substances or Elements									
	Lead and lead compounds	Mercury and mercury compounds	Cadmium and cadmium compounds	Hexavalent chromium compounds	Polybrominated biphenyls	Polybrominated biphenyl ethers	Dibutyl phthalate	Butylbenzyl phthalate	Di-2-ethylhexyl phthalate	Diisobutyl phthalate
Lead frame	○	○	○	○	○	○	○	○	○	○
Plastic resin	○	○	○	○	○	○	○	○	○	○
Chip	○	○	○	○	○	○	○	○	○	○
The lead	○	○	○	○	○	○	○	○	○	○
Plastic sheet installed	○	○	○	○	○	○	○	○	○	○
explanation	○: Indicates that the content of hazardous substances or elements in the detection limit of the following the SJ/T11363-2006 standard. ×: Indicates that the content of hazardous substances or elements exceeding the SJ/T11363-2006 Standard limit requirements.									

6.2、Notes

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